

#### **MICTOR**

TE Internal #: 767114-6

PCB Mount Receptacle, Vertical, Board-to-Board, 228 Position, . 64mm [.025in] Centerline, Fully Shrouded, Gold or Palladium Nickel

or Performance Based

View on TE.com >



Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 228

Centerline (Pitch): .64 mm [ .025 in ]

## **Features**

## **Product Type Features**

Ground Component Type	Ground Bus
PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

# **Configuration Features**

Number of Power Positions	6
Number of Rows	2
Number of Columns	114
Stackable	No
Number of Signal Positions	228
PCB Mount Orientation	Vertical
Number of Positions	228
Board-to-Board Configuration	Parallel

#### **Electrical Characteristics**

Insulation Resistance	2 ΜΩ
Impedance	50 Ω



Operating Voltage	30 VAC
Signal Characteristics	
Differential Signaling	Yes
Data Rate	10 Gb/s
Contact Features	
Contact Layout	Inline
	150 – 250 μin
Contact Shape & Form	Dual Beam
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold or Palladium Nickel or Performance Based
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	11.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.53 mm[.021 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Retention	With
Mating Alignment	With
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Bottom
Centerline (Pitch)	.64 mm[.025 in]
Housing Color	Black
Housing Material	Liquid crystal polymer(LCP)
Dimensions	



Connector Length	88.9 mm[3.5 in]
Connector Height	6 mm[.236 in]
Connector Width	6.9 mm[.272 in]
Row-to-Row Spacing	5.79 mm[.228 in]
Stack Height	6.6 mm, 9 mm, 10.92 mm, 12.57 mm, 17.96 mm, 18.75 mm, 20 mm, 22.86 mm[.9 in]
PCB Thickness (Recommended)	1.57 mm[.8 in]
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Assembly Process Feature	Vacuum Cover
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Agency/Standard	CSA
CSA Certified	Yes
CSA File Number	1195944
UL File Number	E28476
UL Rating	Listed
Packaging Features	
Packaging Quantity	252

# **Product Compliance**

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements:

Pocket Tape



Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per
	homogenous material. Also BFR/CFR/PVC
	Free

Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



# **Customers Also Bought**







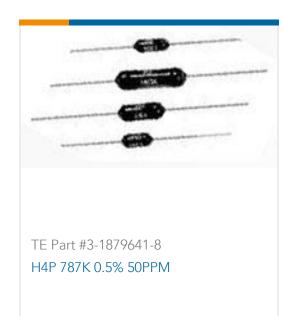


















# **Documents**

**Product Drawings** 

MICT,REC,228,ASY,.025,TAPE,CAP

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_767114-6\_C.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_767114-6\_C.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_767114-6\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English